# PME271E, Metallized Impregnated Paper, Class X1, 300 VAC



**Overview** Applications

Multilayer metallized paper encapsulated and impregnated in self-extinguishing material, meeting the requirements of UL 94 V-0.

For worldwide use as an electromagnetic interference suppressor in all X1 and across-the-line applications.

#### **Benefits**

· Approvals: ENEC, UL

Rated voltage: 300 VAC 50/60 Hz
 Capacitance range: 0.01μF – 0.22 μF

Lead Spacing: 15.2 – 25.4 mm

 Capacitance tolerance: ±20% for C ≤ 0.1μF, ±10% for C > 0.1 μF

- Climatic category: 40/110/56/B, IEC 60068-1
- Tape & Reel packaging in accordance with IEC 60286-2
- RoHS compliance and lead-free terminations
- Operating temperature range of -40°C to +110°C
- 100% screening factory test at 2,150 VDC
- Highest possible safety regarding active and passive flammability



#### **Customer Part Number**

PME271	Е	(D)	510(0)	M	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
X1, Metallized Paper	E = 300	Blank = Standard D = 22.5	The last three digits represent significant figures. The first digit specifies the total number of digits.	M = $\pm 20\%$ (for C ≤ 0.1 μF) K = $\pm 10\%$ (for C > 0.1 μF)	See Ordering Options Table

## **KEMET Internal Part Number**

Р	277	Q	Е	103	M	300	A
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	X1, Metallized Paper	Q = 15.2 C = 20.3 S = 22.5 E = 25.4	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = $\pm 20\%$ (for C $\leq$ 0.1 $\mu$ F) K = $\pm 10\%$ (for C > 0.1 $\mu$ F)	300 = 300	See Ordering Options Table

One world. One KEMET



#### **Benefits cont'd**

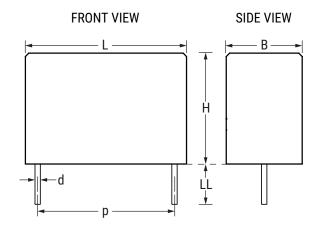
- Excellent self-healing properties which ensure long life even when subjected to frequent overvoltages
- Good resistance to ionization due to impregnated paper dielectric
- · High dv/dt capability
- Impregnated paper ensures excellent stability and reliability properties, particularly in applications with continuous operation

### **Ordering Options Table**

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06
15.0	Bulk (Bag) – Maximum Length Leads	30 +5/-0	Α	R30
15.2	Tape & Reel (Standard Reel)	$H_0 = 18.5 \pm 0.5$	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	Р	R19T1
	Standard Lead and Packaging Options			
	Bulk (Tray) – Short Leads	6 +0/-1	С	R06
20.3	Bulk (Bag) – Maximum Length Leads	30 +5/-0	Α	R30
20.0	Tape & Reel (Standard Reel)	$H_0 = 18.5 \pm 0.5$	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	Р	R19T1
	Standard Lead and Packaging Options			
	0 0 1	6 +0/-1	С	R06
	Bulk (Tray) – Short Leads Bulk (Bag) – Maximum Length Leads	30 +5/-0	A	R30
22.5	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 ±0.5	L	R19T0
	Other Lead and Packaging Options	110-10.0 10.0	_	KIJIO
	Tape & Reel (Large Reel)	H <sub>o</sub> = 18.5 ±0.5	P	R19T1
	Tape & Neel (Large Neel)	110-10.0 ±0.0	Г	1/1711
	Standard Lead and Packaging Options			
25.4	Bulk (Tray) – Short Leads	6 +0/-1	С	R06
	Bulk (Bag) – Maximum Length Leads	30 +5/-0	Α	R30



#### **Dimensions - Millimeters**



0: 0-d-		p	В		Н		L		d	
Size Code	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
QE	15.2	±0.4	5.2	Maximum	10.5	Maximum	18.5	Maximum	0.8	±0.05
QN	15.2	±0.4	7.3	Maximum	13.0	Maximum	19.0	Maximum	0.8	±0.05
QS	15.2	±0.4	8.5	Maximum	14.3	Maximum	18.5	Maximum	0.8	±0.05
CE	20.3	±0.4	7.6	Maximum	14.0	Maximum	24.0	Maximum	0.8	±0.05
СР	20.3	±0.4	11.3	Maximum	16.5	Maximum	24.0	Maximum	0.8	±0.05
SJ	22.5	±0.4	8.0	Maximum	17.0	Maximum	27.0	Maximum	0.8	±0.05
SP	22.5	±0.4	10.0	Maximum	19.0	Maximum	27.0	Maximum	0.8	±0.05
SU	22.5	±0.4	12.0	Maximum	22.0	Maximum	27.0	Maximum	0.8	±0.05
EE	25.4	±0.4	10.6	Maximum	16.1	Maximum	30.5	Maximum	1.0	±0.05
EJ	25.4	±0.4	12.1	Maximum	19.0	Maximum	30.5	Maximum	1.0	±0.05
		No	te: See the Or	dering Options	s Table for lea	d length (LL) o	ptions.			



#### **Performance Characteristics**

300 VAC 50/60 Hz				
0.01 - 0.22 μF				
±20% for C ≤ 0.1 µF, ±10% for C > 0	D.1 μF			
-40°C to +110°C				
40/110/56/B				
ENEC, UL				
Maximum Va	lues at +23°C			
1 kHz 1.3%				
The 100% screening factory test is carried out at 2,150 VDC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. It is not permitted to repeat this test as there is a risk to damage the capacitor. KEMET is not liable in such case for				
Minimum Values E	Between Terminals			
C ≤ 0.33 µF	≥ 12,000 MΩ			
C > 0.33 μF ≥ 4,000 MΩ • μF				
Recommended voltage ≤ 630 VDC				
	0.01 − 0.22 μF  ±20% for C ≤ 0.1 μF, ±10% for C > 0  −40°C to +110°C  40/110/56/B  ENEC, UL  Maximum Va  1 kHz  The 100% screening factory test voltage level is selected to meet equipment standards. All electric after the test. It is not permitted risk to damage the capacitor. KEN any failures.  Minimum Values E  C ≤ 0.33 μF  C > 0.33 μF			

#### **Environmental Test Data**

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	1.25 x V <sub>R</sub> VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s <sup>2</sup>
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s <sup>2</sup>
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V <sub>R</sub> +20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle-flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days



#### **Approvals**

Mark	Specification	File Number
	EN/IEC 60384-14	SE/0140-15D
c <b>Al</b> ®us	UL 60384-14 CAN/CSA-E60384-14-09	E73869

# **Environmental Compliance**

All KEMET EMI capacitors are RoHS Compliant.



# **Table 1 - Ratings & Part Number Reference**

Capacitance	Maximun	Maximum Dimensions in mm			f	dV/dt	New KEMET Part	Legacy Part
Value (µF)	В	Н	L	Spacing (p)	(MHz)	(V/µs)	Number	Number
0.010	5.2	10.5	18.5	15.2	16	1,200	P277QE103M300(1)	PME271E510M(1)
0.015	5.2	10.5	18.5	15.2	13	1,200	P277QE153M300(1)	PME271E515M(1)
0.022	7.3	13	18.5	15.2	9.8	1,200	P277QN223M300(1)	PME271E522M(1)
0.033	7.3	13	18.5	15.2	7	1,200	P277QN333M300(1)	PME271E533M(1)
0.047	8.5	14.3	18.5	15.2	6.4	1,200	P277QS473M300(1)	PME271E547M(1)
0.068	7.6	14	24	20.3	5.2	600	P277CE683M300(1)	PME271E568M(1)
0.1	11.3	16.5	24	20.3	4.1	600	P277CP104M300(1)	PME271E610M(1)
0.068	8	17	27	22.5	4.7	600	P277SJ683M300(1)	PME271ED5680M(1)
0.1	8	17	27	22.5	4.1	600	P277SJ104M300(1)	PME271ED6100M(1)
0.15	10	19	27	22.5	3.2	600	P277SP154K300(1)	PME271ED6150K(1)
0.22	12	22	27	22.5	2.5	600	P277SU224K300(1)	PME271ED6220K(1)
0.15	10.6	16.1	30.5	25.4	3.3	400	P277EE154K300(1)	PME271E615K(1)
0.22	12.1	19	30.5	25.4	2.6	400	P277EJ224K300(1)	PME271E622K(1)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f <sub>。</sub> (MHz)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

<sup>(1)</sup> Insert lead and packaging code. See Ordering Options Table for available options.



#### **Soldering Process**

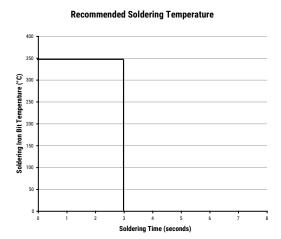
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of  $183^{\circ}$ C for SnPb eutectic alloy to  $217 - 221^{\circ}$ C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is  $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm), and great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the recommended limits may result in degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface-mount components. Insert through-hole parts after curing the surface-mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum of two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

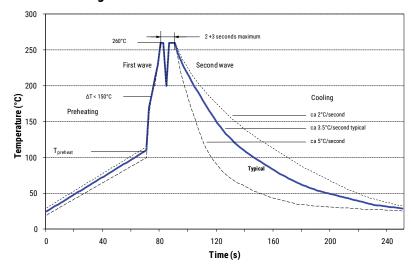
#### **Manual Soldering Recommendations**

Following is the recommendation for manual soldering with a soldering iron.



Soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





#### **Soldering Process cont'd**

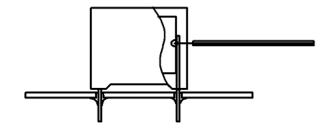
#### **Wave Soldering Recommendations cont'd**

1. The table indicates the maximum setup temperature for the soldering process.

Dielectric film	Maximun	n Preheat Ten		eak Soldering erature	
material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm Capacitor		Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor: set the temperature so that inside the element the maximum temperature is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

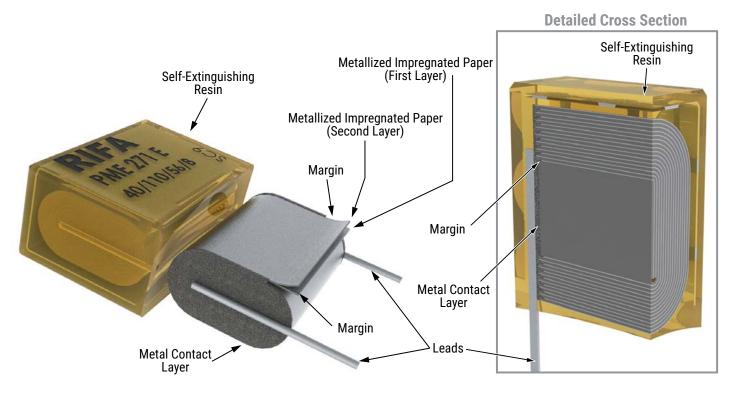
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath, as in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

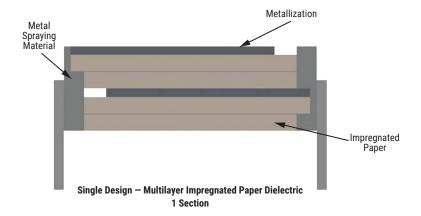
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering. Great care must be taken so that the parts do not overheat.



#### Construction

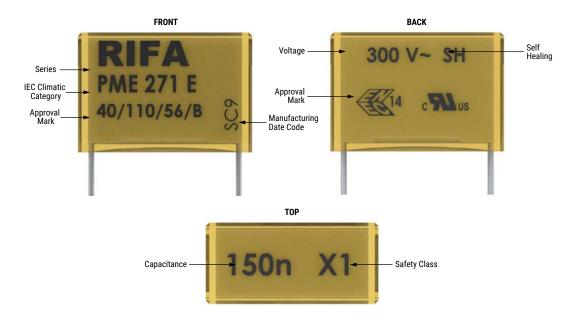


#### **Winding Scheme**





# **Marking**



# **Packaging Quantities**

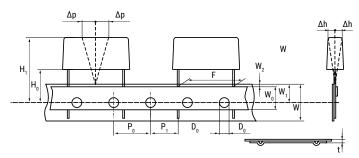
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 360 mm	Large Reel 500 mm
	5.5	12.5	18.0	1,000	500	600	
	6.5	12.5	18.0	600	400	400	
	7.5	14.5	18.0	600	400	400	
	8.5	16.0	18.0	400	250	400	
15.2	5.2	10.5	18.5	1,000	500	600	
15.2	5.5	11.1	18.5	1,000	500	500	
	6.0	12.5	18.5	600	400	400	
	7.3	13.0	18.5	600	400	400	800
	7.8	13.5	18.5	600	400	400	
	8.5	14.3	18.5	500	300	350	
		110	21.2	1.500		250	
	7.6	14.0	24.0	1,500	250	250	500
20.3	8.4	14.0	24.0	1,200	200	250	500
20.5	9.0	15.0	24.0	1,500	200	250	
	11.3	16.5	24.0	1,000	150	180	400
	8.0	17.0	27.0	1,200	200		
22.5	10.0	19.0			150	200	
22.5		-	27.0	1,000			050
	12.0	22.0	27.0	800	100	180	350
	10.6	16.1	30.5	1,000	150		
07.4	10.5	17.3	30.5	1,000	100		
25.4	12.1	19.0	30.5	800	100		
	15.3	22.0	30.5	600	75		



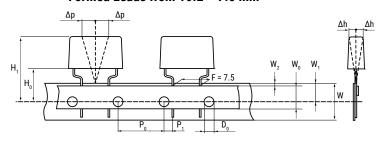
### Lead Taping & Packaging (IEC 60286-2)

#### Lead Spacing 10.2 - 15.2 mm

#### Lead Spacing 20.3 - 22.5 mm



Formed Leads from 10.2 - 7.5 mm



### **Taping Specification**

	Standard IEC 60286-2							
Lead Spacing	+6/-0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F
Carrier Tape Width	±0.5	W	18.0	18.0	18.0	18.0	18.0	18 +1/-0.5
Hold-Down Tape Width	Minimum	$W_{0}$	5.0	5.0	5.0	5.0	5.0	
Position of Sprocket Hole	±0.5	W <sub>1</sub>	9.0	9.0	9.0	9.0	9.0	9 +0.75/-0.5
Distance Between Tapes	Maximum	$W_2$	3.0	3.0	3.0	3.0	3.0	3.0
Sprocket Hole Diameter	±0.2	$D_{o}$	4.0	4.0	4.0	4.0	4.0	4.0
Feed Hole Lead Spacing	±0.3	P <sub>0</sub> <sup>(1)</sup>	12.7(4)	12.7	12.7	12.7	12.7	12.7
Distance Lead - Feed Hole	±0.7	P <sub>1</sub>	3.75	7.6	5.1	8.9	5.3	P <sup>1</sup>
Deviation Tape - Plane	Maximum	Δр	1.3	1.3	1.3	1.3	1.3	1.3
Lateral Deviation	Maximum	Δh	2.0	2.0	2.0	2.0	2.0	2.0
Total Thickness	±0.2	t	0.7	0.7	0.7	0.7	0.9 Maximum	0.9 Maximum
Sprocket Hole/Cap Body	Nominal	H <sub>0</sub> <sup>(2)</sup>	18 +2/-0	18 +2/-0	18 +2/-0	18 +2/-0	18.5 ±0.5	18 +2/-0
Sprocket Hole/Top of Cap Body	Maximum	H <sub>1</sub> <sup>(3)</sup>	43	43	43	58	58	58 Maximum

<sup>(1)</sup> Maximum cumulative feed hole error, 1 mm per 20 parts

<sup>(2) 16.5</sup> mm available on request

<sup>(3)</sup> Depending on case size

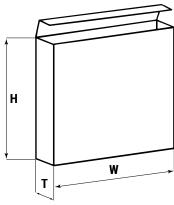
<sup>(4) 15</sup> mm available on request



# Lead Taping & Packaging (IEC 60286-2) cont'd

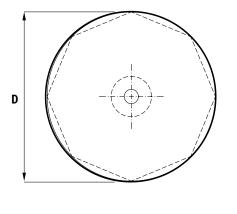
# **Ammo Specifications**

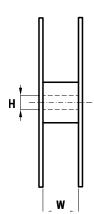
Carias	Dimensions (mm)		
Series	Н	W	Т
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	360	340	59
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx	330	330	50



# **Reel Specifications**

Carias	Dimensions (mm)		
Series	D	Н	W
R4x, R4x+R, R7x, RSB	055		
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	300	25	
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)





# **Manufacturing Date Code (IEC-60062)**

Y = Year, Z = Month					
Year	Code	Month	Code		
2010	Α	January	1		
2011	В	February	2		
2012	С	March	3		
2013	D	April	4		
2014	E	May	5		
2015	F	June	6		
2016	Н	July	7		
2017	J	August	8		
2018	K	September	9		
2019	L	October	0		
2020	M	November	N		
2021	N	December	D		
2022	Р				
2023	R				
2024	S				
2025	Т				
2026	U				
2027	V				
2028	W				
2029	X				
2030	Α				



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